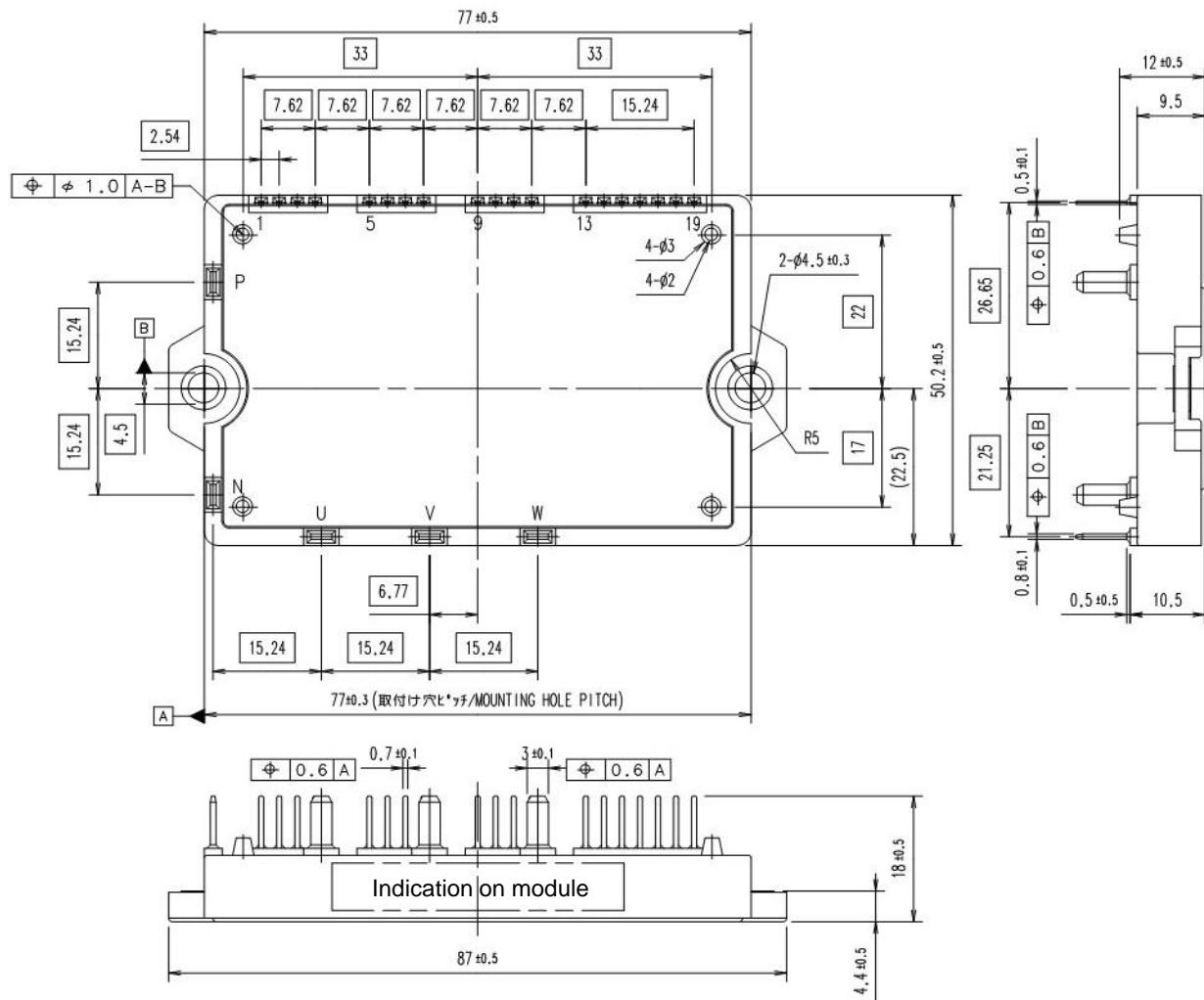


6MBP25XBA120-50

IGBT Modules
IGBT Module (X series)
1200V / 25A / IPM
■ Features

- Temperature protection provided by directly detecting the junction temperature of the IGBTs
- Low power loss and soft switching
- High performance and high reliability IGBT with overheating protection
- Higher reliability because of a big decrease in number of parts in built-in control circuit


■ Outline drawing (Unit : mm)


Weight:100g(typ.)

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IGBT Modules

■ Absolute maximum ratings

 $T_c=25^\circ\text{C}$, $T_{vj}=25^\circ\text{C}$, $V_{CC}=15\text{V}$ unless otherwise specified

Item	Symbol	Conditions	Min.	Max.	Units
Collector-emitter voltage	V_{CES}	*1	-	1200	V
Short circuit voltage	V_{SC}	*2	400	800	V
Inverter Collector current	I_C	DC	-	25	A
	I_{CP}	1ms	-	50	A
	$-I_C$	Duty=100% *3	-	25	A
Total power dissipation	P_{tot}	IGBT 1 device *4	-	189	W
Brake Collector current	I_C	DC	-	-	A
	I_{CP}	1ms	-	-	A
Forward current of diode	I_F		-	-	A
Total power dissipation	P_{tot}	IGBT 1 device *4	-	-	W
Supply voltage of pre-driver	V_{CC}	*5	-0.5	20	V
Input signal voltage	V_{in}	*6	-0.5	$V_{CC}+0.5$	V
Alarm signal voltage	V_{ALM}	*7	-0.5	V_{CC}	V
Alarm signal current	I_{ALM}	*8	-	20	mA
T_{vj} Warning signal voltage	V_{WNG}	*9	-0.5	V_{CC}	V
T_{vj} Warning signal current	I_{WNG}	*10	-	20	mA
Virtual junction temperature	T_{vj}		-	175	°C
Operating virtual junction temperature	T_{vjop}		-	150	°C
Operating case temperature	T_c		-20	125	°C
Storage temperature	T_{stg}		-40	125	°C
Solder temperature	T_{sol}	*11	-	260	°C
Isolating voltage	V_{isol}	*12	-	2500	Vrms
Mounting torque of screws to heat sink	M_s	Mounting(M4)	-	1.7	Nm
Mounting torque of screws to terminals	M_t	Main terminals(M4)	-	-	Nm

Notes

*1: V_{CES} shall be applied to the input voltage between terminal P-(U,V, W) and (U,V, W)-N.

*2: In the case of the load inductance to be over 1μH.

*3: Duty=150°C/R_{th(j-c)D}/($I_F \times V_F$ Max.)×100

*4: $P_{tot}=150^\circ\text{C}/R_{th(j-c)Q}$

*5: V_{CC} shall be applied to the input voltage between terminal No.4 and 1, 8 and 5, 12 and 9, 14 and 13.

*6: V_{in} shall be applied to the input voltage between terminal No.3 and 1, 7 and 5, 11 and 9, 16~18 and 13.

*7: V_{ALM} shall be applied to the voltage between terminal No.2 and 1, 6 and 5, 10 and 9, 19 and 13.

*8: I_{ALM} shall be applied to the input current to terminal No.2,6,10 and 19.

*9: V_{WNG} shall be applied to the voltage between terminal No.15 and 13.

*10: I_{WNG} shall be applied to the input current to terminal No.15.

*11: Immersion time 10±1sec. 1 time.

*12: Terminal to base, 50/60Hz sine wave 1 min. All terminals should be connected together during the test.

■ Electrical characteristics

● Main circuit

 $T_{vj}=25^\circ\text{C}$, $V_{CC}=15\text{V}$ unless otherwise specified

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
Inverter Collector current at off signal input	I_{CES}	$V_{CE} = 1200\text{V}$	-	-	1.0	mA
	$V_{CE(\text{sat})}$	$I_C = 25\text{A}$	Terminal	-	1.85	V
			Chip	-	1.45	V
Forward voltage of FWD	V_F	$I_F = 25\text{A}$	Terminal	-	2.35	V
			Chip	-	1.90	V
			-	-	-	mA
Brake Collector current at off signal input	I_{CES}		-	-	-	V
	$V_{CE(\text{sat})}$		Terminal	-	-	V
			Chip	-	-	V
Forward voltage of FWD	V_F		Terminal	-	-	V
			Chip	-	-	V
			-	-	-	V
Switching time *13	t_{on}	$I_C = 25\text{A}$ $T_{vj}=150^\circ\text{C}$ $V_{DC} = 600\text{V}$	0.5	-	-	μs
	$t_{d(on)}$		0.5	-	-	μs
	t_{off}		-	-	2.0	μs
	$t_{d(off)}$		-	-	1.7	μs
	t_{rr}	$I_F = 25\text{A}$ $T_{vj}=150^\circ\text{C}$ $V_{DC} = 600\text{V}$	-	-	0.5	μs

*13: Turn on time (t_{on}) = $t_{d(on)} + t_r$, Turn off time (t_{off}) = $t_{d(off)} + t_f$

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● Control circuit

 $T_{vj}=25^{\circ}\text{C}$, $V_{cc}=15\text{V}$ unless otherwise specified

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
Supply current of P-side pre-driver (per one unit)	I_{ccp}	Switching frequency (f_{sw}) = 0~15kHz $T_c = -20\sim125^{\circ}\text{C}$	-	-	9	mA
Supply current of N-side pre-driver	I_{ccn}		-	-	23	mA
Input signal threshold voltage	$V_{inth(on)}$	V_{in} -GND	ON	1.2	1.4	1.6
	$V_{inth(off)}$		OFF	1.5	1.7	1.9
						V

● Protection circuit

 $T_{vj}=25^{\circ}\text{C}$, $V_{cc}=15\text{V}$ unless otherwise specified

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
Over current protection level	Inverter	$T_{vj}=150^{\circ}\text{C}$	38	-	-	A
			-	-	-	A
Over current protection delay time	t_{dOC}	$T_{vj}=150^{\circ}\text{C}$	-	4.0	-	μs
Short circuit protection delay time	t_{dSC}	$T_{vj}=150^{\circ}\text{C}$	-	1.0	-	μs
IGBT chips over heating protection temperature level	T_{jOH}	Surface of IGBT chips	175	-	-	$^{\circ}\text{C}$
Over heating protection hysteresis	T_{jH}		-	20	-	$^{\circ}\text{C}$
IGBT chips warning temperature level	T_{jW}	Surface of IGBT chips (Y)	150	-	-	
Warning hysteresis	T_{jWH}		-	10	-	
Under voltage protection level	V_{UV}		11.0	-	12.5	V
Under voltage protection hysteresis	V_H		0.2	0.5	-	V
Alarm signal hold time	$t_{ALM(OC)}$	ALM-GND $T_c=-20\sim125^{\circ}\text{C}$	1.0	2.0	2.4	ms
	$t_{ALM(UV)}$		3.5	4.0	4.5	ms
	$t_{ALM(TjOH)}$		7.0	8.0	9.0	ms
Warning signal hold time	t_{WNG}	WNG-GND $T_c=-20\sim125^{\circ}\text{C}$	T_{jw} operating ~ cancellation			ms
Alarm signal voltage	V_{ALMH}	ALM-GND, without protection	14.5	-	15.0	V
Warning signal voltage	V_{WNGH}	WNG-GND, without warning	14.5	-	15.0	V
Resistance for current limit	R_{ALM}		960	-	1570	Ω
	R_{WNG}		960	-	1570	Ω

■ Thermal resistance characteristics ($T_c = 25^{\circ}\text{C}$)

Item	Symbol	Min.	Typ.	Max.	Units
Thermal resistance junction to case *14	IGBT	$R_{th(i-c)Q}$	-	-	0.79 K/W
	FWD	$R_{th(i-c)D}$	-	-	1.18 K/W
	IGBT	$R_{th(i-c)Q}$	-	-	K/W
	FWD	$R_{th(i-c)D}$	-	-	K/W
Thermal resistance case to heat sink *15	$R_{th(c-s)}$	-	0.05	-	K/W

*14: For 1 device , the measurement point of the case is just under the chip.

*15: This is the value which is defined mounting on the additional heat sink with 1 W/(m·K) thermal grease.

■ Noise immunity ($V_{dc}=600\text{V}$, $V_{cc}=15\text{V}$)

Item	Conditions	Min.	Typ.	Max.	Units
Common mode rectangular noise	Pulse width 1 μs ,polarity $\pm 10\text{min}$. Judge: no over-current, no miss operating	± 2.0	-	-	kV

■ Recommended operating conditions

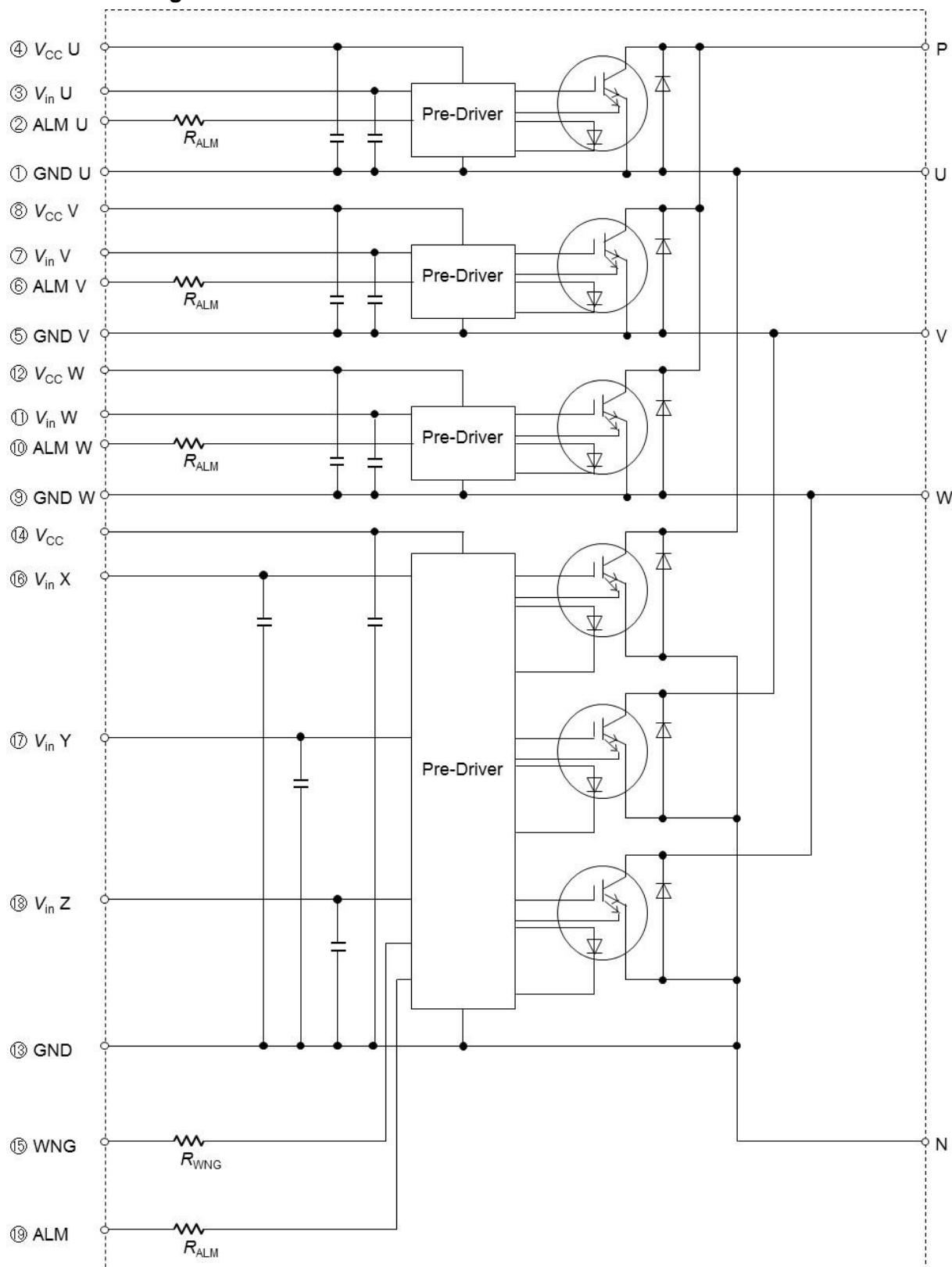
Item	Symbol	Min.	Typ.	Max.	Units
DC bus voltage	V_{dc}	-	-	800	V
Power supply voltage of pre-driver	V_{cc}	13.5	15.0	16.5	V
Switching frequency of IPM	f_{sw}	-	-	20.0	kHz
Arm shoot through blocking time for IPM's input signal *16	t_{dead}	1.5	-	-	μs
Screw torque (M4)	-	-	1.3	-	1.7 Nm

*16: $t_{dead} = t_{off} - t_{d(on)}$

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IGBT Modules

■ Block diagram



Pre-drivers include following functions

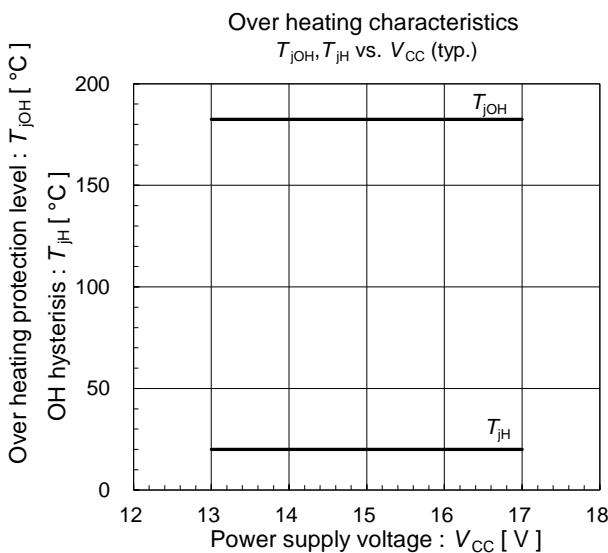
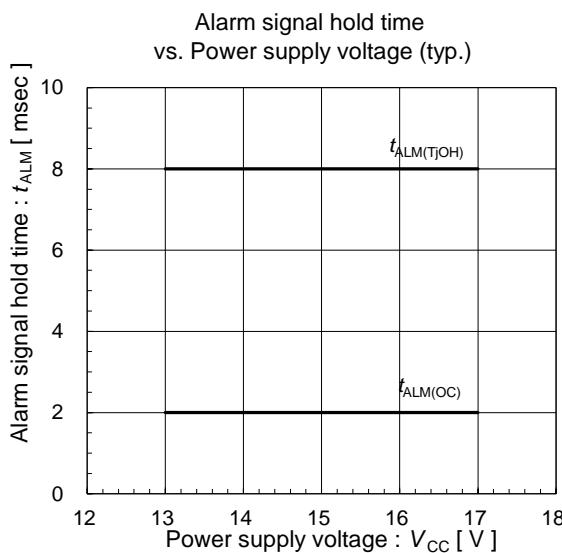
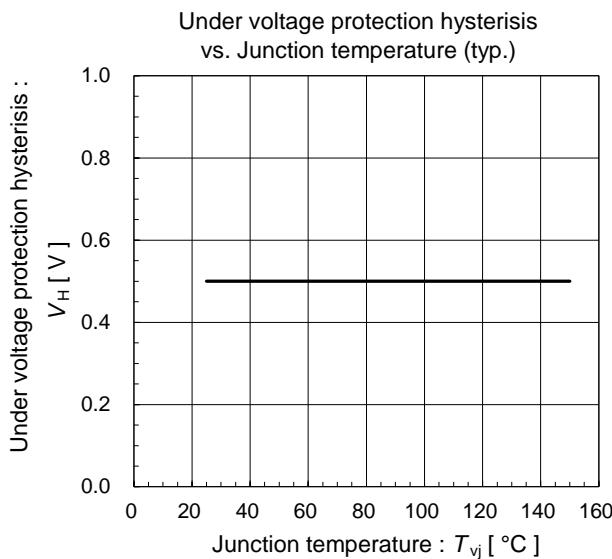
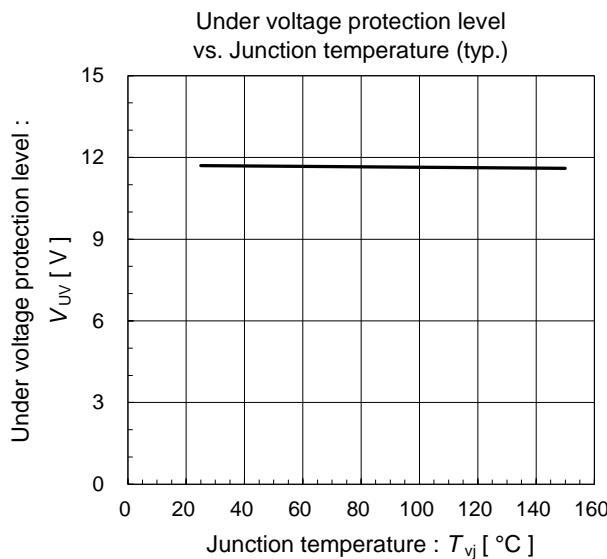
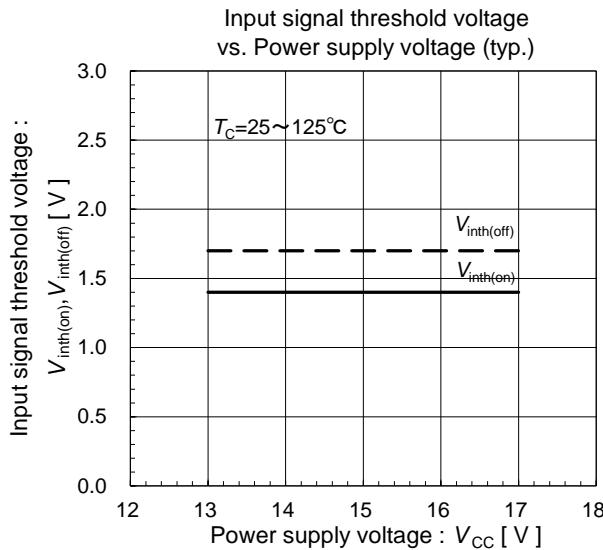
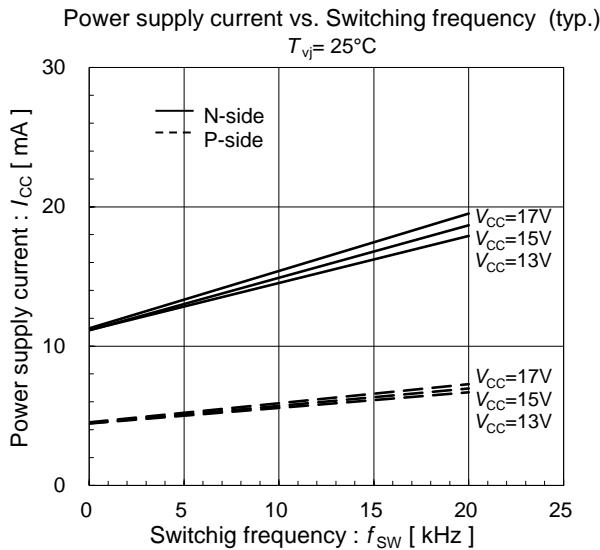
1. Amplifier for driver
2. Short circuit protection
3. Under voltage lockout circuit
4. Over current protection
5. IGBT chip over heating protection

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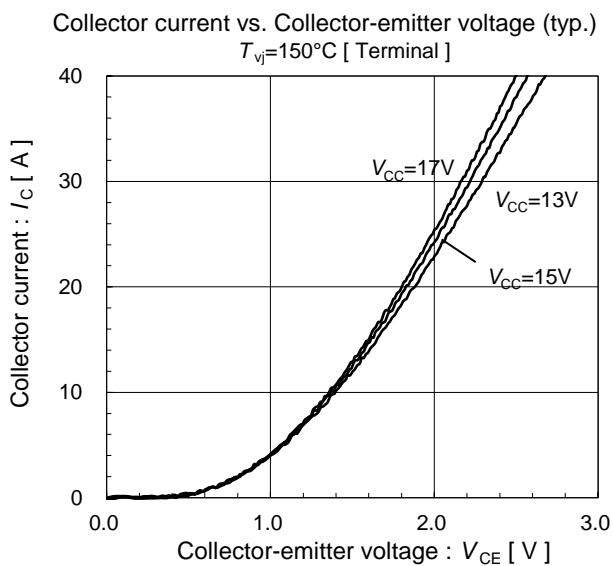
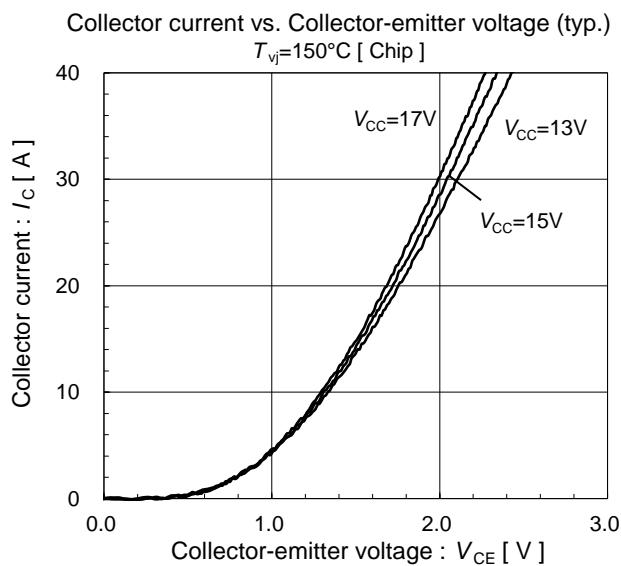
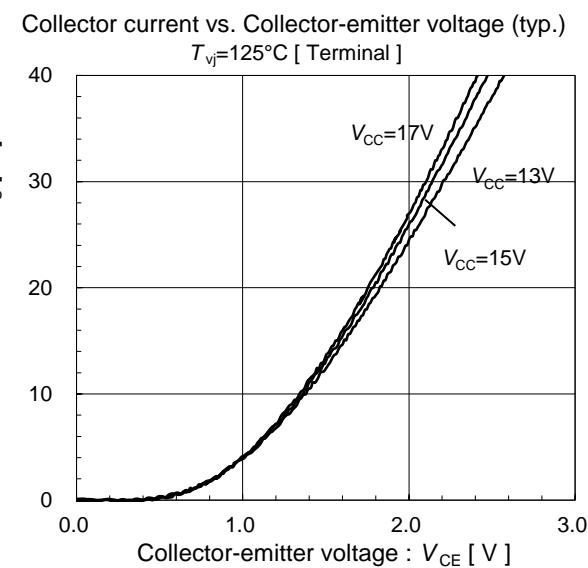
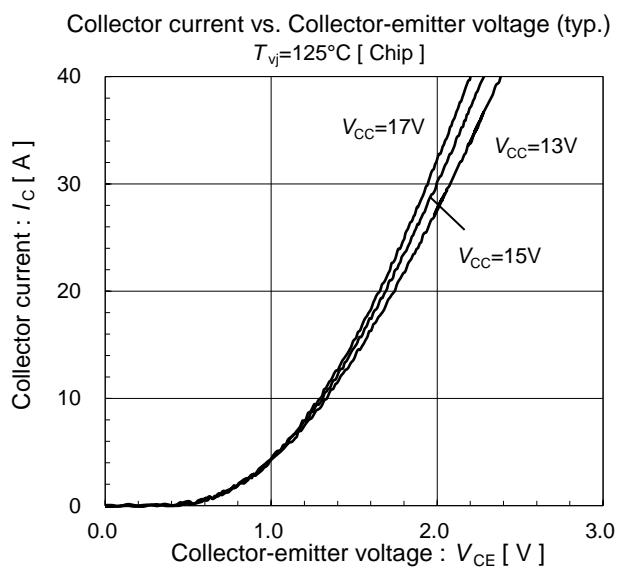
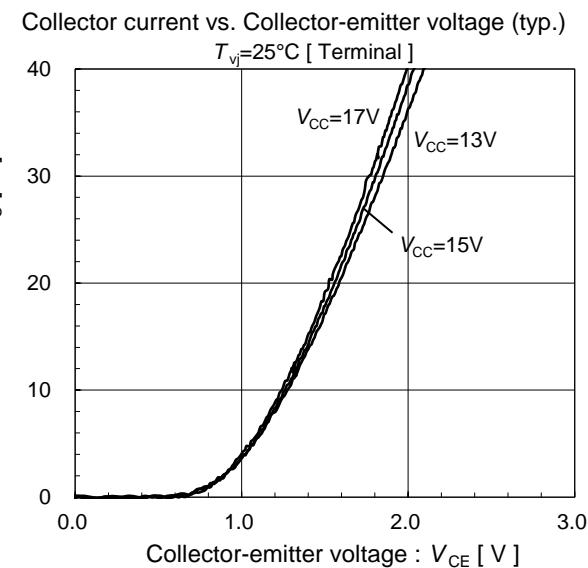
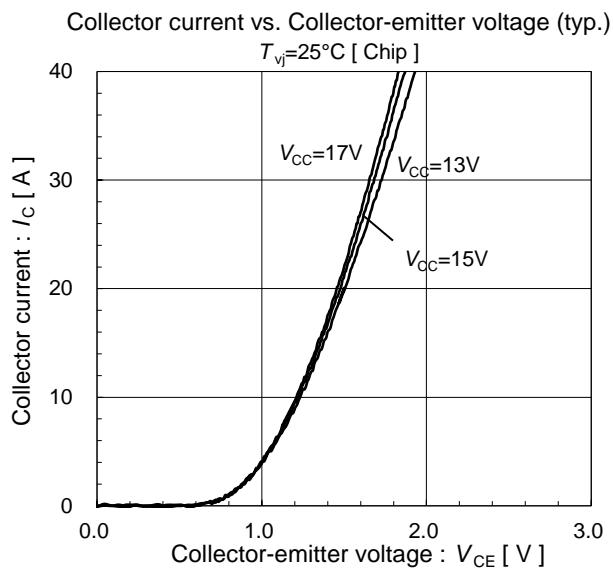
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■ Characteristics (representative)

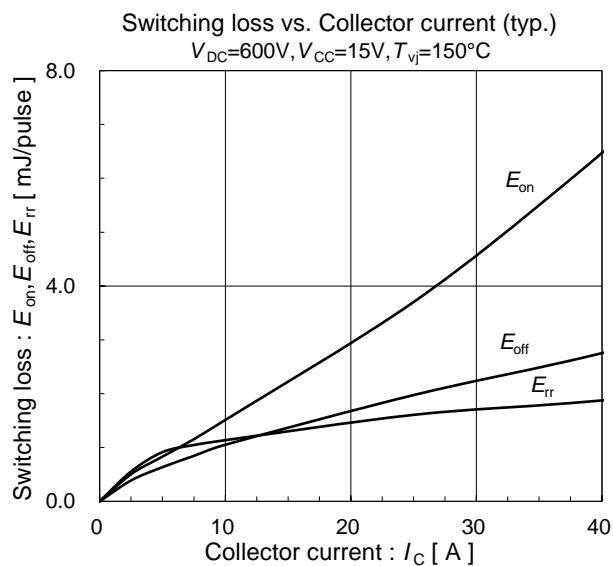
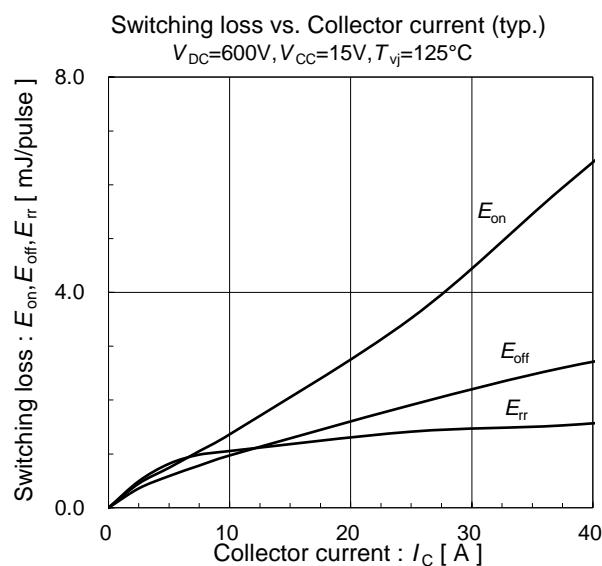
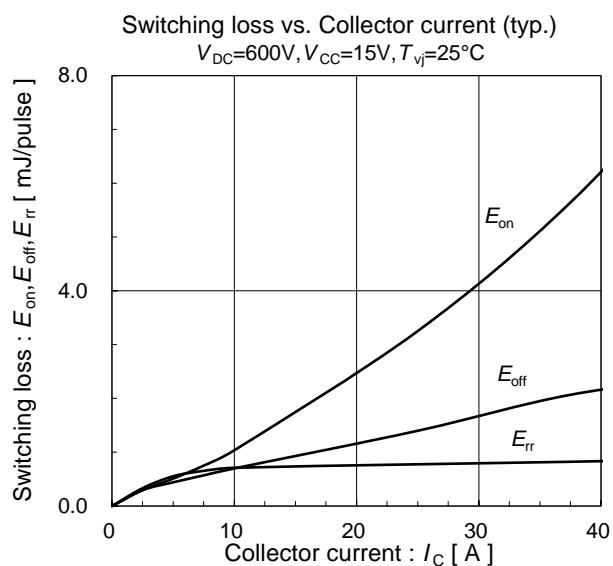
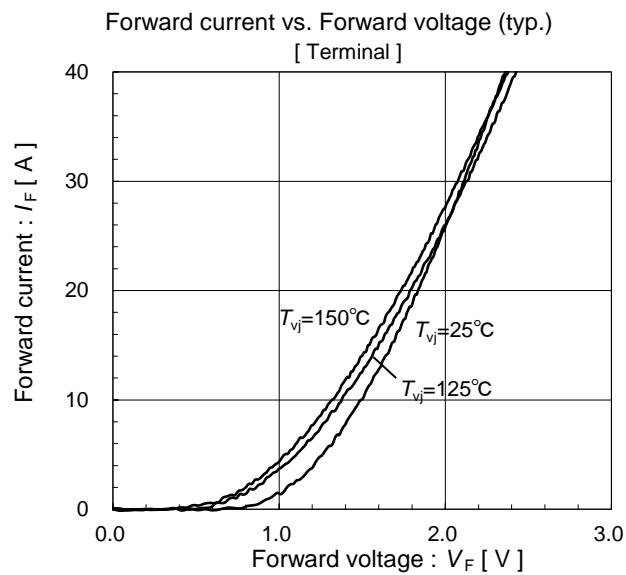
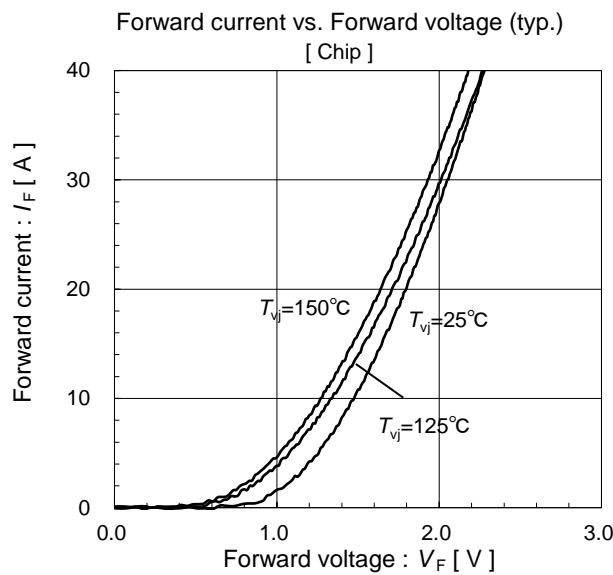
- Control circuit



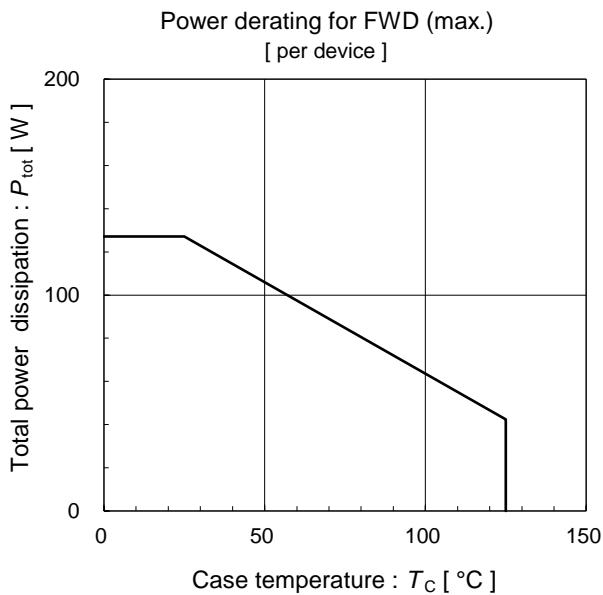
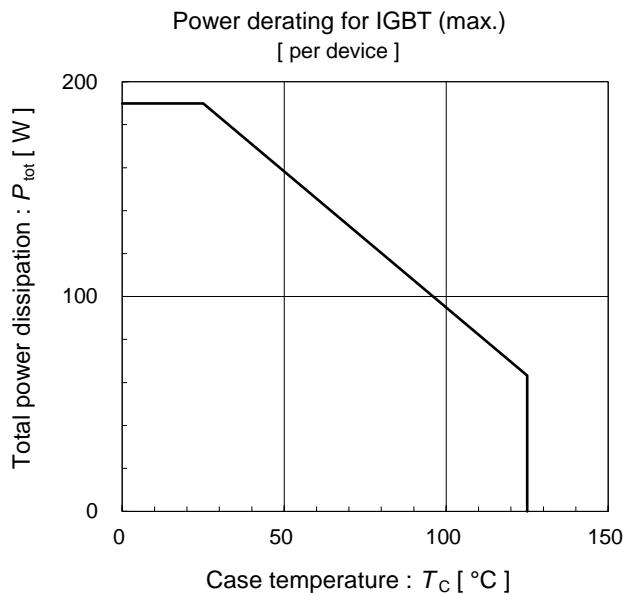
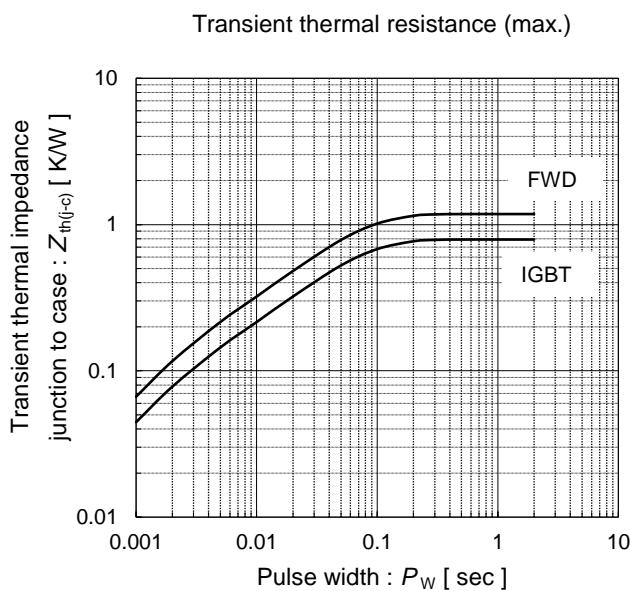
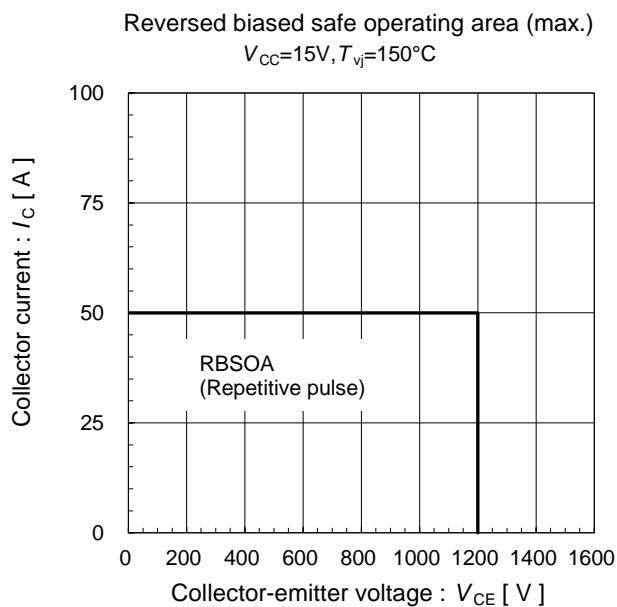
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IGBT Modules
● Inverter


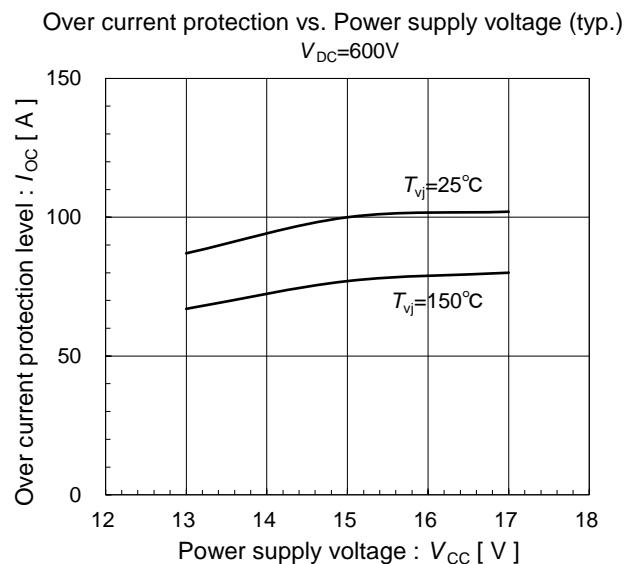
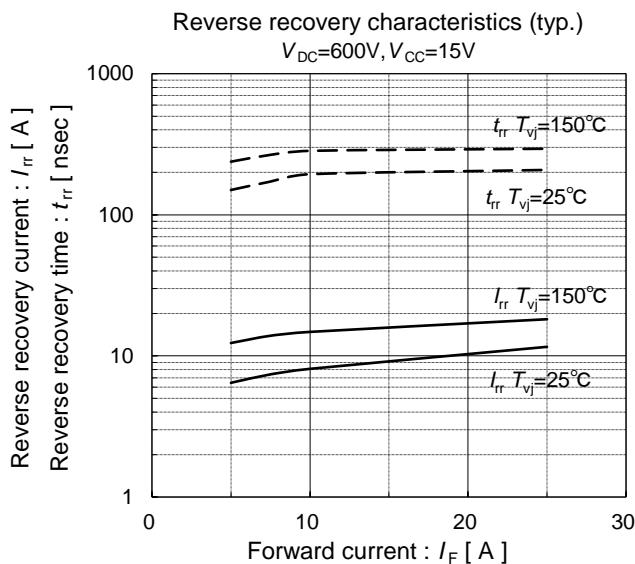
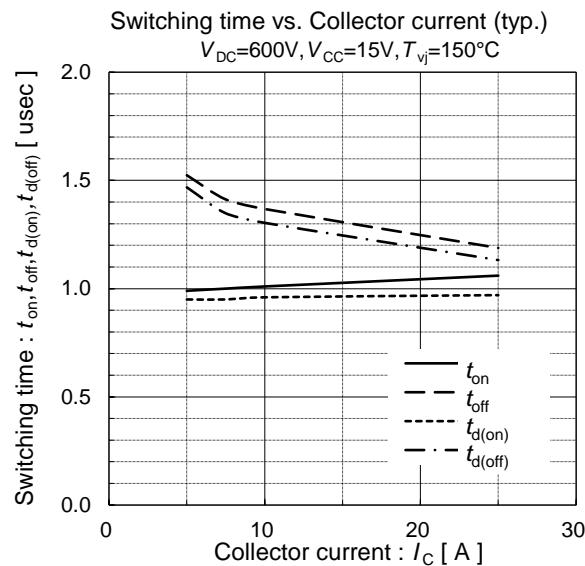
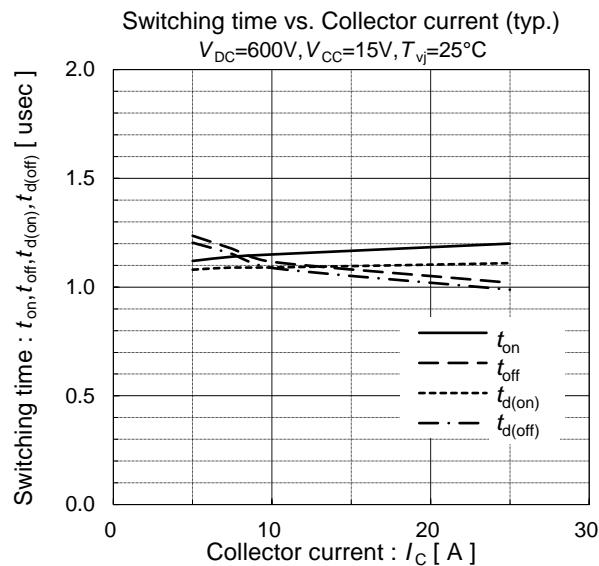
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